CRMGGL0304A

N-Channel 30V, 3.7mΩ Typ. Power MOSFET

Description

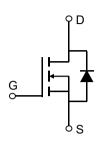
Features

• 30V, 80A

$$R_{DS(ON)}$$
 Typ = 3.7m Ω @ V_{GS} = 10V

$$R_{DS(ON)}$$
 Typ = 5.3m Ω @ V_{GS} = 4.5V

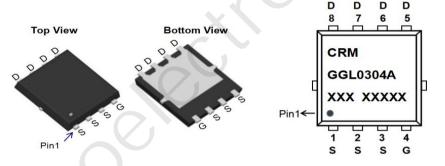
- Advanced Split Gate Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!





Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMGGL0304A	CRMGGL0304A	PDFN5x6-8L	TAPING	13"	5000	50000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		30	V
V_{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	80	А
I _D		T _C = 100°C	48	Α
I _{DM}	Pulsed Drain Current (1)		320	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		56	mJ
P_{D}	Power Dissipation	T _C = 25°C	52	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		2.4	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.5	2.2	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 10V, I_D = 20A$	-	3.7	4.8	mΩ
		$V_{GS} = 4.5V, I_D = 10A$	-	5.3	6.9	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-(953	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz	X - \	446	-	pF
C_{rss}	Reverse Transfer Capacitance	1 - 1101112	- 1	34	-	pF
Q_g	Total Gate Charge		J -	17	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 20V, I_{D} = 50A$	-	4.5	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} = 20 V, I _D = 00/1	-	2	-	nC
Switchin	g Characteristics					
$t_{d(on)}$	Turn-On DelayTime		-	6.5	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 20V$	-	2.7	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 50A$, $R_{GEN} = 3\Omega$	-	26	-	ns
t _f	Turn-Off Fall Time	·		3.6		ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current			-	80	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	320	Α
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 - 504 di/dt - 1004/:	-	22	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 50A$, di/dt = 100A/us	-	40	-	nC
	T T T T T T T T T T T T T T T T T T T					

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =15V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =15A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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Test Circuit

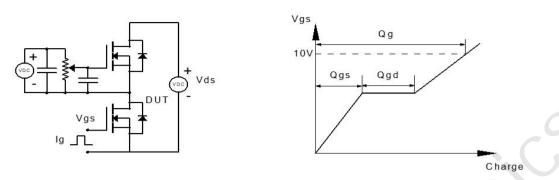


Figure 1: Gate Charge Test Circuit & Waveform

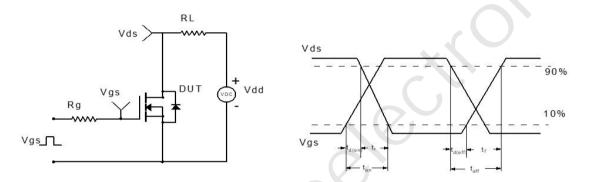


Figure 2: Resistive Switching Test Circuit & Waveform

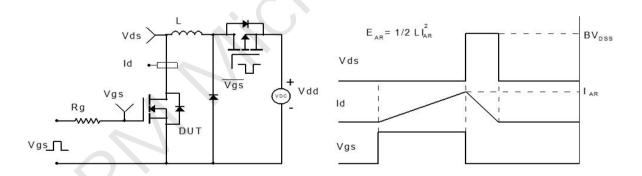


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

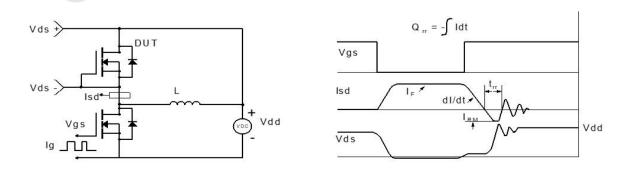
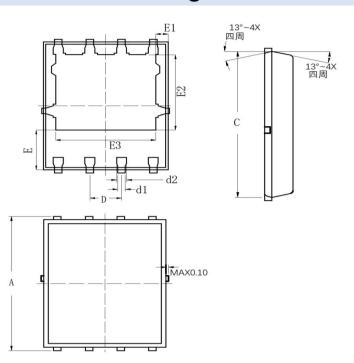


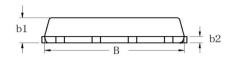
Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(PDFN5x6-8L)





COMMON DIMENSION (MM)						
PKG		PDFN 5×6-8L				
SYMBOL	MIN	TYP	MAX			
А	6.000	6.100	6.200			
В	4.875	4.900	4.925			
b1	0.975	1.000	1.025			
b2	0.246	0.254	0.262			
С	5.775	5.800	5.825			
D	1.245	1.270	1.295			
d1	0.275	0.300	0.325			
d2	0.375	0.400	0.425			
E	1.725	1.775	1.825			
E1	0.395	0.445	0.495			
E2	3.425	3.475	3.525			
E3	3.960	4.010	4.060			

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